

### Product Change Notification / GBNG-21TAFW674

## Date:

23-Mar-2022

## **Product Category:**

Memory

# PCN Type:

Manufacturing Change

### **Notification Subject:**

CCB 4354.002 Final Notice: Qualification of MTAI as an additional assembly site for selected AT24C512C device family available in 8L SOIC (3.90mm) package.

### Affected CPNs:

GBNG-21TAFW674\_Affected\_CPN\_03232022.pdf GBNG-21TAFW674\_Affected\_CPN\_03232022.csv

# Notification Text:

PCN Status: Final Notification

PCN Type: Manufacturing Change

**Microchip Parts Affected:**Please open one of the files found in the Affected CPNs section. Note: For your convenience Microchip includes identical files in two formats (.pdf and .xls)

**Description of Change:**Qualification of MTAI as an additional assembly site for selected AT24C512C device family available in 8L SOIC (3.90mm) package.

#### Pre and Post Change Summary:

Pre Change	Post Change
	Page 1 of 3

Assembly Site	ASE Advanced Semiconductor (Shanghai) Co., Ltd	ASE Advanced Semiconductor (Shanghai) Co., Ltd	Microchip Technology Thailand				
	ASSH	ASSH	(HQ) (MTAI)				
Wire Material	CuPdAu	CuPdAu	CuPdAu				
Die Attach Material	EN-4900G	EN-4900G	8390A				
Molding Compound Material	CEL-9240HF10AK	CEL-9240HF10AK	G600V				
Lead-Frame Material	C194	C194	CDA194				
Lead-Frame Paddle Size	93 x 93 mils	93 x 93 mils	90 x 90 mils				
Lead-Frame Lead-lock	No	No	Yes				
Lead-Frame Design	See attached Pre and Post Change comparison						

\*Note: C194, A194 or CDA194 Lead frame material are the same, it is just a MCHP internal labelling difference

#### Impacts to Data Sheet:None

#### Change ImpactNone

**Reason for Change:**To improve on-time delivery performance by qualifying MTAI as an additional assembly site.

#### Change Implementation Status: In Progress

Estimated First Ship Date: April 15, 2022 (date code: 2216)

Note: Please be advised that after the estimated first ship date customers may receive pre and post change parts.

#### Time Table Summary:

	March 2022				April 2022					
Workweek	10	11	12	1 3	14	15	16	17	18	
Final PCN Issue Date				х						
Qual Report Availability				х						
Estimated Implementation Date							х			

Method to Identify Change: Traceability code

**Qualification Report:**Please open the attachments included with this PCN labeled as PCN\_#\_Qual\_Report.

Revision History: March 23, 2022: Issued final notification.

The change described in this PCN does not alter Microchip's current regulatory compliance regarding the material content of the applicable products.

### Attachments:

PCN\_GBNG-21TAFW674\_Pre and Post Change\_Summary.pdf PCN\_GBNG-21TAFW674\_Qual\_Report.pdf

Please contact your local Microchip sales office with questions or concerns regarding this notification.

#### **Terms and Conditions:**

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If you wish to <u>change your PCN profile</u>, <u>including opt out</u>, please go to the <u>PCN home page</u> select login and sign into your myMicrochip account. Select a profile option from the left navigation bar and make the applicable selections. GBNG-21TAFW674 - CCB 4354.002 Final Notice: Qualification of MTAI as an additional assembly site for selected AT24C512C device family available in 8L SOIC (3.90mm) package.

Affected Catalog Part Numbers (CPN)

AT24C512C-SSHD-B AT24C512C-SSHM-B AT24C512C-SSHD-T AT24C512C-SSHM-T